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SL3145

1.6GHz NPN TRANSISTOR ARRAYS

The SL3145 is a monolithic array of five high frequency low current NPN transistors. The SL3145 consists of 3 isolated transistors and a differential pair in a 14 lead SO package The transistors exhibit typical $f\tau s$ of 1.6GHz and wideband noise figures of 3.0dB The device is pin compatible with the CA3046.

FEATURES

- f_⊤ Typically 1.6GHz
- Wideband Noise Figure 3.0dB
- V_{BE} Matching Better Than 5mV

Fig.1 Pin connections SL3145

APPLICATIONS

- Wide Band Amplifiers
- PCM Regenerators
- High Speed Interface Circuits
- High Performance Instrumentation Amplifiers
- High Speed Modems

ORDERING INFORMATION

SL3145 C MP

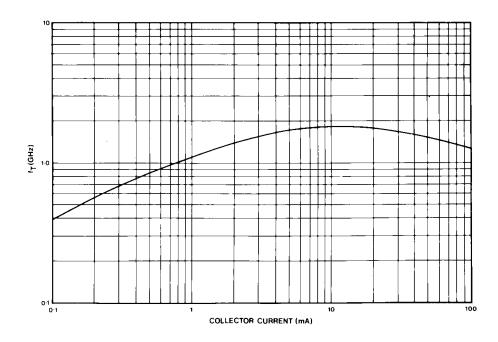


Fig.2 Transition frequency (f_T) v. collector current (V_{CB} = 2V, f=200MHz)

ELECTRICAL CHARACTERISTICS

These characteristics are guaranteed over the following test conditions (unless otherwise stated)

 $T_{amb} = 22^{\circ}C \pm 2^{\circ}C$

Characteristic	Symbol	Value			Units	Conditions
) Cymisei	Min.	Тур.	Max.		Conditions
Static characteristic						
Collector base breakdown	ВУсво	20	30		V	$Ic = 10\mu A$, $Ie = 0$
Collector emitter breakdown	LVceo	15	18		V	Ic = 1mA, IB = 0
Collector substrate breakdown (isolation)	BVcio	20	55		V	$Ic = 10\mu A$, $IR = IE = 0$
Base to isolation breakdown	ВVвю	10	20		V	$I_B = 10\mu A$, $I_C = I_E = 0$
Base emitter voltage	VBE	0.64	0.74	0.84	V	Vce = 6V, Ic = 1mA
Collector emitter saturation voltage	Vce(SAT)		0.26	0.5	V	Ic = 10mA, $IB = 1mA$
Emitter base leakage current	ІЕВО		0.1	1	μΑ	$V_{EB} = 4V$
Base emitter saturation voltage	VBE(SAT)		0.95		V	Ic = 10mA, $IB = 1mA$
Base emitter voltage difference,	ΔV be		0.45	5	mV	Vce = 6V, Ic = 1mA
all transistors expect TR1, TR2						
Base emitter voltage difference	ΔV be		0.35	5	mV	VcE = 6V, $Ic = 1mA$
TR1, TR2						
Input offset current	ΔI_B		0.2	3	μΑ	$V_{CE} = 6V$, $I_{C} = 1mA$
(except for TR1, TR2)						
Input offset current TR1, TR2	ΔI_B		0.2	2	μΑ	Vce = 6V, Ic = 1mA
Temperature coefficient of ΔV _{BE}	∂ <u>ΔV</u> <u>be</u>		2.0		μV/°C	
	∂T				l .	
Temperature coefficiient of VBE	∂ <u>V</u> be		-1.6		mV/°C	Vce = 6V, Ic = 1mA
	∂T					
Static forward current ratio	HFE	40	100			Vce = 6V, Ic = 1mA
Collector base leakage	Ісво		0.3		nA	VcB = 16V
Collector isolation leakage	Icio		0.6		nA	Vci = 20V
Base isolation leakage	Івю		100		nA	Vві = 5V
Emitter base capacitance	Сев		0.4		pF	Veb = 0V
Collector base capacitance					·	
SL3145	Ссв		0.4		pF	$V_{CB} = 0V$
Collector isolation capacitance	Ссі		0.8		pF	Vcı = 0V
Dynamic characteristics						
Transition frequency						
SL3145	f⊤		1.6		GHz	$V_{CE} = 6V$, $I_{C} = 5mA$
Wideband noise figure	NF		3.0		dB	$V_{CE} = 2V$, $R_S = 1k\Omega$
						$Ic = 100\mu A, f = 60MHz$
Knee of 1/f noise curve			1		KHz	$V_{CE} = 6V$, $R_S = 200\Omega$
						Ic = 2mA

ABSOLUTE MAXIMUM RATINGS

The absolute maximum ratings are limiting values above which operating life may be shortened or specified parameters may be degraded.

All electrical ratings apply to individual transistors. Thermal ratings apply to the total package.

The isolation pin (substrate) must be connected to the most negative voltage applied to the package to maintain electrical isolation.

VcB = 20 volt

 $V_{EB} = 4.0 \text{ volt}$

Vce = 15 volt

Vci = 20 volt

Ic = 20 mA

Maximum individual transistor dissipation 200 mWatt Storage temperature -55°C to 150°C Max junction temperature 150°C

Package thermal resistance (°C/watt):-

Package Type MP14
Chip to case 45°C/W
Chip to ambient 123°C/W

NOTE:

If all the power is being dissipated in one transistor, these thermal resistance figures should be increased by 100°C/watt

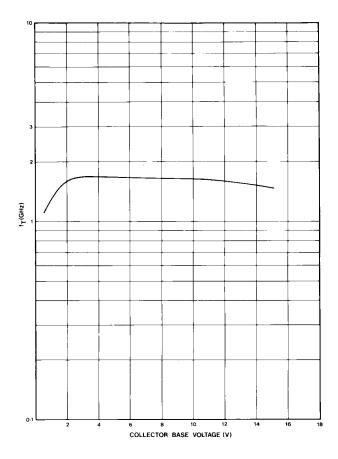


Fig.3 Transition frequency ($f\tau$) v. collector base voltage (Ic = 5mA, Frequency = 200MHz)

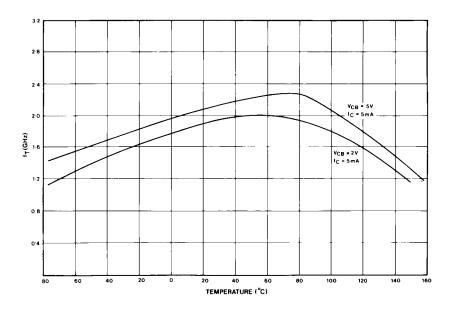


Fig.4 Variation of transition frequency (fT) with temperature

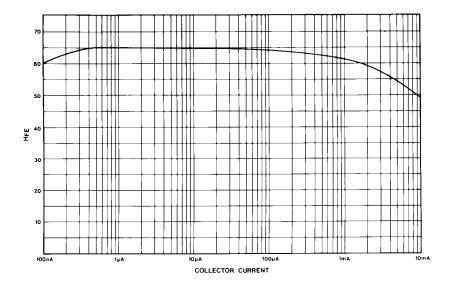


Fig.5 DC current gain v. collector current

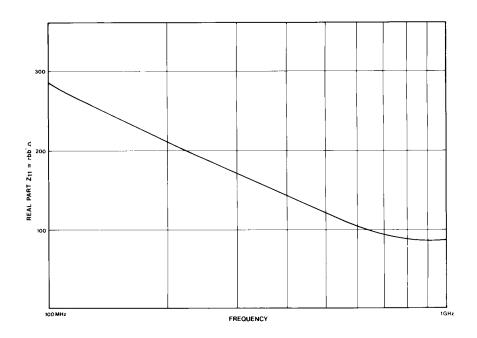


Fig.6 Z₁₁ (derived from scattering parameters) v. frequency (Z₁₁ __<rb)



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